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Class	Subclass
ISSUE CLASSIFICATION	

PATENT NUMBER

U.S. UTILITY Patent Application

O.I.P.E. SCANNED <i>MH</i> <i>Bm²</i> Q.A. <i>AA</i>	PATENT DATE
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APPLICATION NO. 09/712314	CONT/PRIOR	CLASS 250	SUBCLASS <i>2081</i>	ART UNIT 2878	EXAMINER <i>alla</i>
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APPLICANTS

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Steven Webster
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TITLE

Chip size sensor wirebond package fabrication method

PTO-2040
12/99

ISSUING CLASSIFICATION

ORIGINAL		CROSS REFERENCE(S)					
CLASS	SUBCLASS	CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)				
INTERNATIONAL CLASSIFICATION							

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	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
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